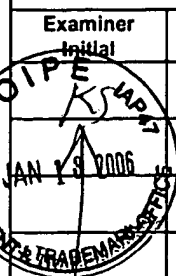


PTO-1449 INFORMATION DISCLOSURE STATEMENT BY APPLICANT <u>LIST OF ITEMS</u> (Use several sheets if necessary)	Attorney's Docket Number JEN-0111-P	Serial Number 10/665,391
	Name of Applicant Shuhua Jin et al	
	Filing Date 09/19/2003	Group 1714

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Examiner Initial	Document Number	Date	NAME	Class	Subclass	Filing Date if Appropriate
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	3 179 623	04/20/1965	Bowen			
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	3 751 399	08/07/1973	Lee et al			
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6 417 246 B1	07/09/2002	Jia et al				

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	Feher, Frank J., et al. "Silsesquioxanes As Models For Silica Surfaces", American Chemical Society, 1989, Vol. 111, pp. 1741-1748

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* **EXAMINER:** Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not conformance and not considered. Include copy of this form with next communication to applicant.